

NTF3055-160

Preferred Device

Power MOSFET 2.0 Amps, 60 Volts N-Channel SOT-223

Designed for low voltage, high speed switching applications in power supplies, converters and power motor controls and bridge circuits.

Applications

- Power Supplies
- Converters
- Power Motor Controls
- Bridge Circuits

MAXIMUM RATINGS ($T_C = 25^\circ\text{C}$ unless otherwise noted)

Rating	Symbol	Value	Unit
Drain-to-Source Voltage	V_{DSS}	60	Vdc
Drain-to-Gate Voltage ($R_{GS} = 1.0\text{ M}\Omega$)	V_{DGR}	60	Vdc
Gate-to-Source Voltage	V_{GS}	± 20	Vdc
– Non-repetitive ($t_p \leq 10\text{ ms}$)		± 30	Vpk
Drain Current	I_D	2.0	Adc
– Continuous @ $T_A = 25^\circ\text{C}$		1.2	
– Continuous @ $T_A = 100^\circ\text{C}$		6.0	Apk
– Single Pulse ($t_p \leq 10\text{ }\mu\text{s}$)	I_{DM}		
Total Power Dissipation @ $T_A = 25^\circ\text{C}$ (Note 1.)	P_D	2.1	W
Total Power Dissipation @ $T_A = 25^\circ\text{C}$ (Note 2.)		1.3	W
Derate above 25°C		0.014	W/ $^\circ\text{C}$
Operating and Storage Temperature Range	T_J, T_{stg}	-55 to 175	$^\circ\text{C}$
Single Pulse Drain-to-Source Avalanche Energy – Starting $T_J = 25^\circ\text{C}$ ($V_{DD} = 25\text{ Vdc}$, $V_{GS} = 10\text{ Vdc}$, $I_L(\text{pk}) = 6.0\text{ Apk}$, $L = 10\text{ mH}$, $V_{DS} = 60\text{ Vdc}$)	E_{AS}	65	mJ
Thermal Resistance	$R_{\theta JA}$	72.3	$^\circ\text{C/W}$
– Junction to Ambient (Note 1.)		114	
– Junction to Ambient (Note 2.)			
Maximum Lead Temperature for Soldering Purposes, 1/8" from case for 10 seconds	T_L	260	$^\circ\text{C}$

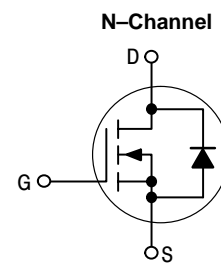
1. When surface mounted to an FR4 board using 1" pad size, (Cu. Area 1.127 in²).
2. When surface mounted to an FR4 board using minimum recommended pad size, 2–2.4 oz. (Cu. Area 0.272 in²).



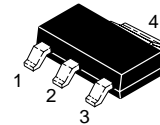
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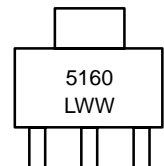
2.0 AMPERES
60 VOLTS
 $R_{DS(on)} = 160\text{ m}\Omega$



MARKING DIAGRAM

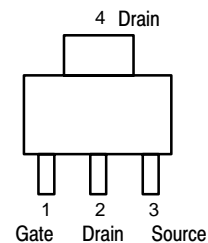


SOT-223
CASE 318E
STYLE 3



5160 = Device Code
L = Location Code
WW = Work Week

PIN ASSIGNMENT



ORDERING INFORMATION

Device	Package	Shipping
NTF3055-160T1	SOT-223	1000 Tape & Reel
NTF3055-160T3	SOT-223	4000 Tape & Reel
NTF3055-160T3LF	SOT-223	4000 Tape & Reel

www.DataSheet4U.com

NTF3055-160

ELECTRICAL CHARACTERISTICS (T_A = 25°C unless otherwise noted)

Characteristic	Symbol	Min	Typ	Max	Unit
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OFF CHARACTERISTICS

Drain-to-Source Breakdown Voltage (Note 3.) (V _{GS} = 0 Vdc, I _D = 250 μAdc) Temperature Coefficient (Positive)	V _{(BR)DSS}	60 –	72 72	– –	Vdc mV/°C
Zero Gate Voltage Drain Current (V _{DS} = 60 Vdc, V _{GS} = 0 Vdc) (V _{DS} = 60 Vdc, V _{GS} = 0 Vdc, T _J = 150°C)	I _{DSS}	– –	– –	1.0 10	μAdc
Gate-Body Leakage Current (V _{GS} = ± 20 Vdc, V _{DS} = 0 Vdc)	I _{GSS}	–	–	± 100	nAdc

ON CHARACTERISTICS (Note 3.)

Gate Threshold Voltage (Note 3.) (V _{DS} = V _{GS} , I _D = 250 μAdc) Threshold Temperature Coefficient (Negative)	V _{GS(th)}	2.0 –	3.1 6.6	4.0 –	Vdc mV/°C
Static Drain-to-Source On-Resistance (Note 3.) (V _{GS} = 10 Vdc, I _D = 1.0 Adc)	R _{DS(on)}	–	142	160	mΩ
Static Drain-to-Source On-Resistance (Note 3.) (V _{GS} = 10 Vdc, I _D = 2.0 Adc) (V _{GS} = 10 Vdc, I _D = 1.0 Adc, T _J = 150°C)	V _{DS(on)}	–	0.142 0.270	0.384 –	Vdc
Forward Transconductance (Note 3.) (V _{DS} = 8.0 Vdc, I _D = 1.5 Adc)	g _{fs}	–	1.8	–	Mhos

DYNAMIC CHARACTERISTICS

Input Capacitance	(V _{DS} = 25 Vdc, V _{GS} = 0 V, f = 1.0 MHz)	C _{iss}	–	200	280	pF
Output Capacitance		C _{oss}	–	68	100	
Transfer Capacitance		C _{rss}	–	26	40	

SWITCHING CHARACTERISTICS (Note 4.)

Turn-On Delay Time	(V _{DD} = 30 Vdc, I _D = 2.0 Adc, V _{GS} = 10 Vdc, R _G = 9.1 Ω) (Note 3.)	t _{d(on)}	–	9.2	20	ns
Rise Time		t _r	–	9.2	20	
Turn-Off Delay Time		t _{d(off)}	–	16	40	
Fall Time		t _f	–	9.2	20	
Gate Charge	(V _{DS} = 48 Vdc, I _D = 2.0 Adc, V _{GS} = 10 Vdc) (Note 3.)	Q _T	–	6.9	14	nC
		Q ₁	–	1.4	–	
		Q ₂	–	3.0	–	

SOURCE-DRAIN DIODE CHARACTERISTICS

Forward On-Voltage	(I _S = 2.0 Adc, V _{GS} = 0 Vdc) (I _S = 2.0 Adc, V _{GS} = 0 Vdc, T _J = 150°C) (Note 3.)	V _{SD}	– –	0.86 0.70	1.0 –	Vdc
Reverse Recovery Time	(I _S = 2.0 Adc, V _{GS} = 0 Vdc, dI _S /dt = 100 A/μs) (Note 3.)	t _{rr}	–	28.9	–	ns
		t _a	–	19.1	–	
		t _b	–	9.8	–	
Reverse Recovery Stored Charge		Q _{RR}	–	0.030	–	μC

3. Pulse Test: Pulse Width ≤ 300 μs, Duty Cycle ≤ 2.0%.

4. Switching characteristics are independent of operating junction temperatures.

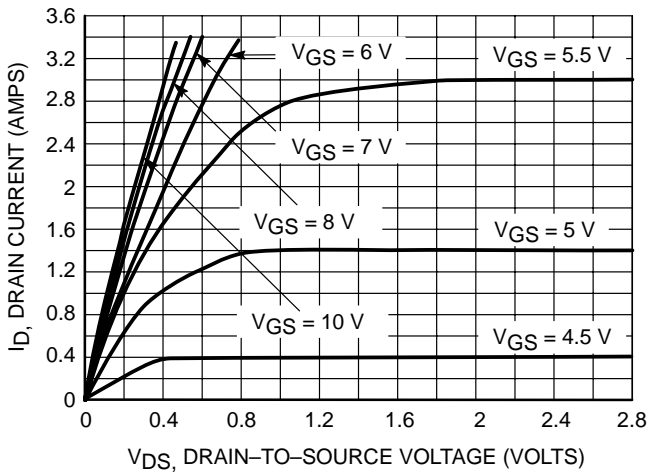


Figure 1. On-Region Characteristics

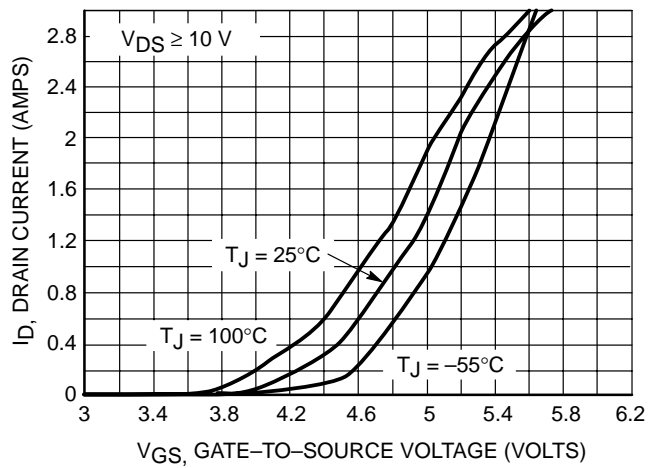


Figure 2. Transfer Characteristics

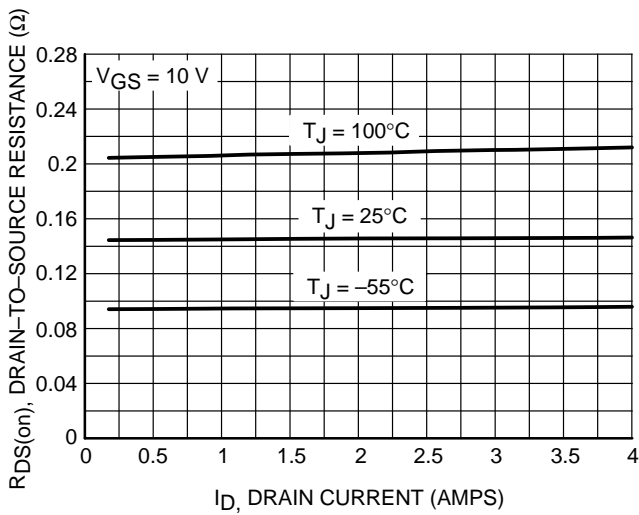


Figure 3. On-Resistance versus Gate-to-Source Voltage

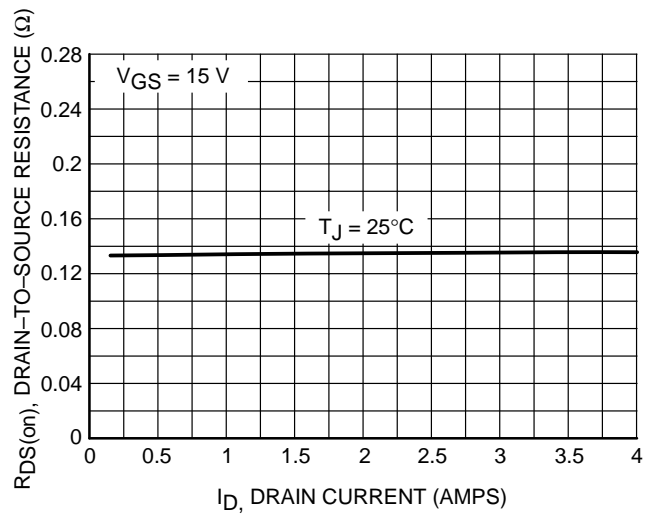


Figure 4. On-Resistance versus Drain Current and Gate Voltage

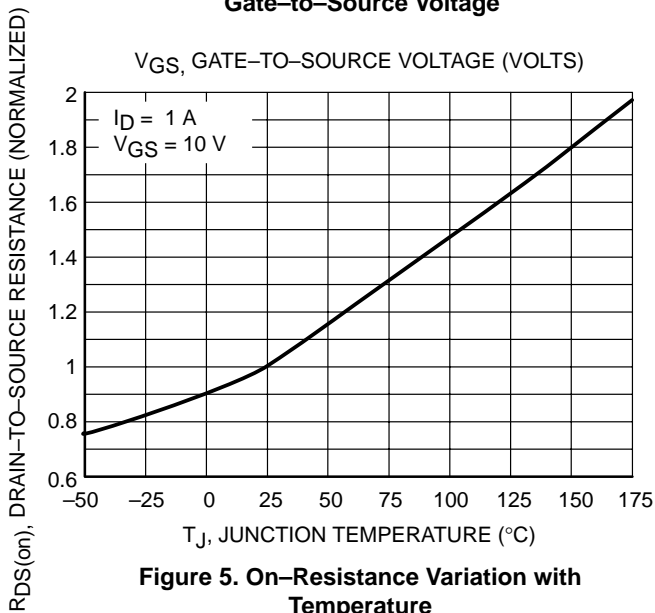


Figure 5. On-Resistance Variation with Temperature

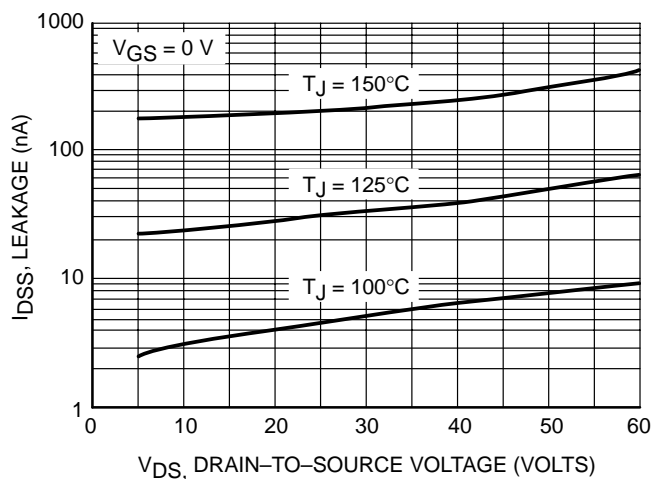


Figure 6. Drain-to-Source Leakage Current versus Voltage

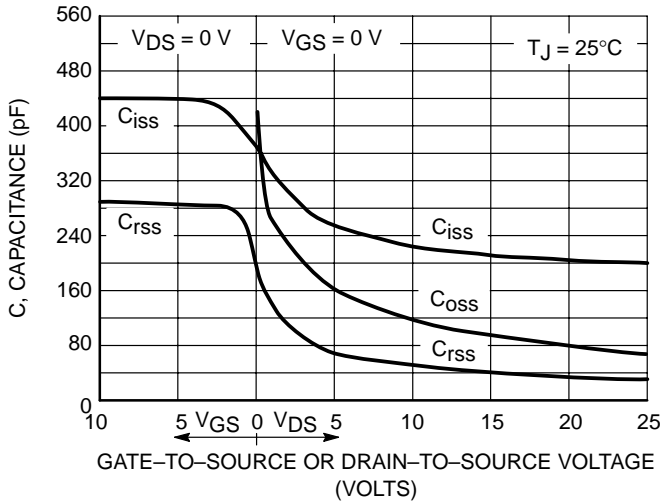


Figure 7. Capacitance Variation

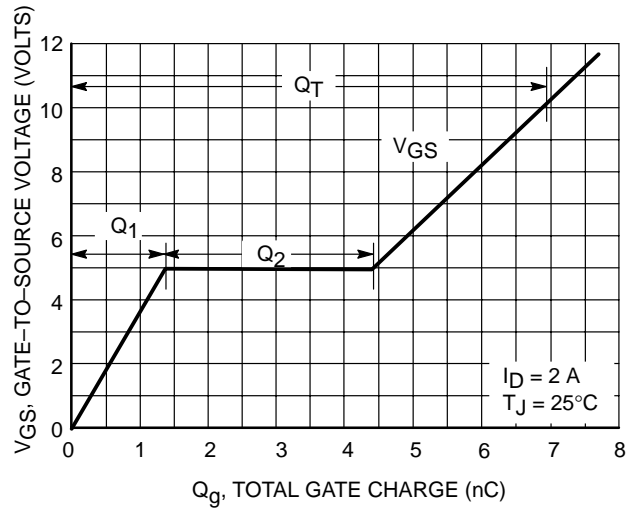


Figure 8. Gate-to-Source and Drain-to-Source Voltage versus Total Charge

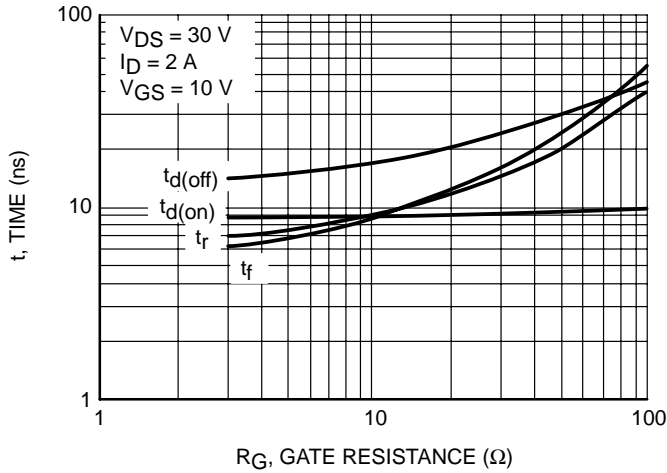


Figure 9. Resistive Switching Time Variation versus Gate Resistance

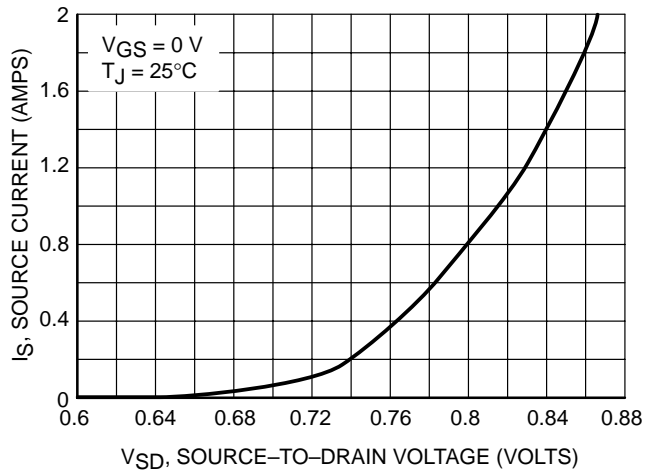


Figure 10. Diode Forward Voltage versus Current

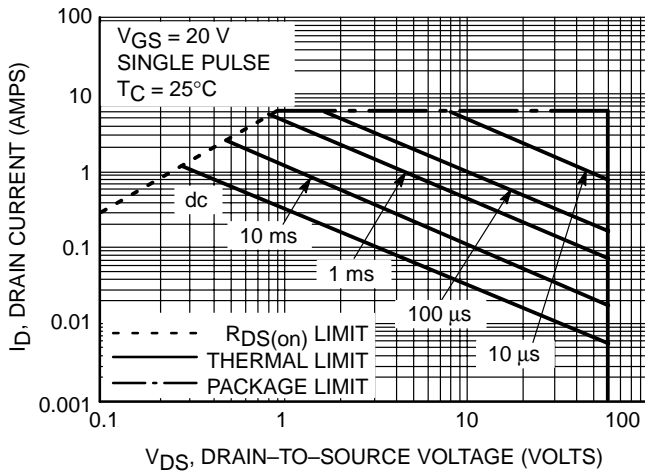


Figure 11. Maximum Rated Forward Biased Safe Operating Area

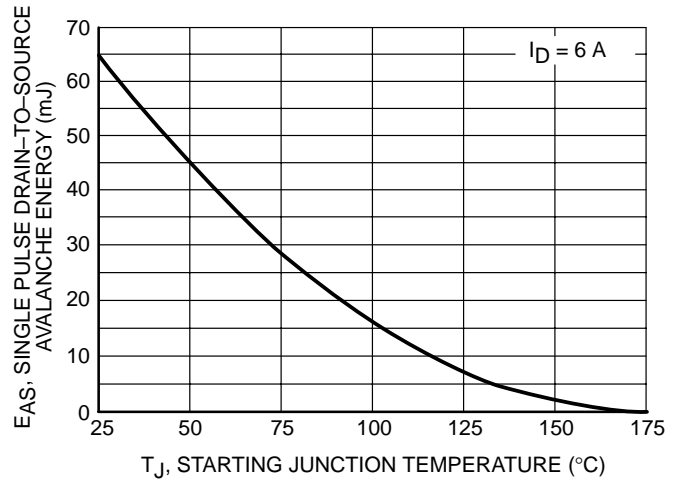


Figure 12. Maximum Avalanche Energy versus Starting Junction Temperature

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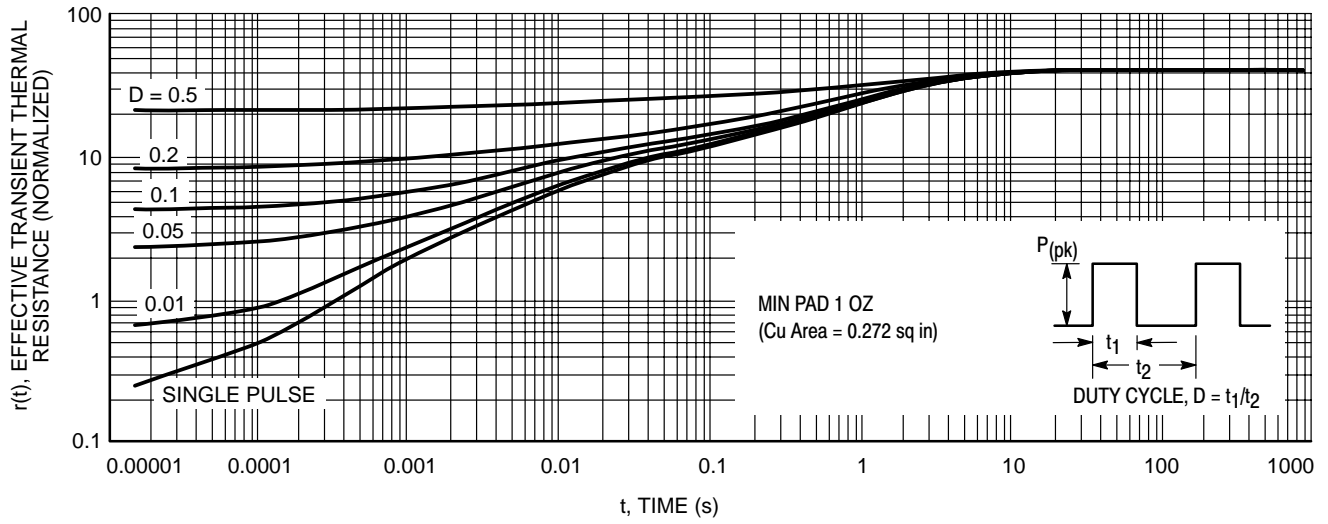
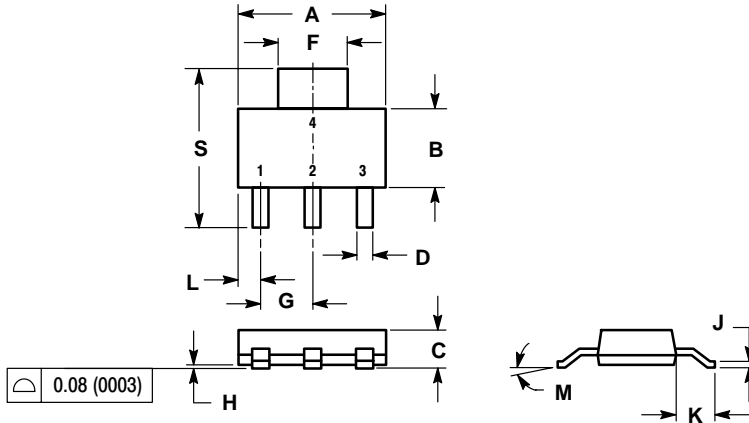


Figure 13. Thermal Response

NTF3055-160

PACKAGE DIMENSIONS

SOT-223 (TO-261)
CASE 318E-04
ISSUE K



NOTES:


1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: INCH.

DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.249	0.263	6.30	6.70
B	0.130	0.145	3.30	3.70
C	0.060	0.068	1.50	1.75
D	0.024	0.035	0.60	0.89
F	0.115	0.126	2.90	3.20
G	0.087	0.094	2.20	2.40
H	0.0008	0.0040	0.020	0.100
J	0.009	0.014	0.24	0.35
K	0.060	0.078	1.50	2.00
L	0.033	0.041	0.85	1.05
M	0°	10°	0°	10°
S	0.264	0.287	6.70	7.30

STYLE 3:

- PIN 1. GATE
- 2. DRAIN
- 3. SOURCE
- 4. DRAIN

Notes

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